Unit in mm

TOSHIBA Photocoupler GaAs Ired & Photo-Transistor

TLP127

Programmable Controllers DC-Output Module Telecommunication

The TOSHIBA mini flat coupler TLP127 is a small outline coupler, suitable for surface mount assembly.

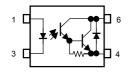
TLP127 consists of a gallium arsenide infrared emitting diode, optically coupled to a darlington photo transistor with an integral base–emitter resistor, and provides 300 V VCEO.

- Collector-emitter voltage: 300 V (min.)
- Current transfer ratio: 1000% (min.)
- Isolation voltage: 2500Vrms (min.)
- UL recognized: UL1577, file no. E67349

7.0 ± 0.4 0.4 0.4 0.5 MIN. 11-4C1

Weight: 0.09 g

Pin Configurations (top view)



- 1 : ANODE
- 3 : CATHODE
- 4 : EMITTER
- 6 : COLLECTOR

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Maximum Ratings (Ta = 25°C)

Characteristic		Symbol	Rating	Unit
Forward current		lF	50	mA
	Forward current derating	ΔI _F / °C	–0.7 (Ta ≥ 53°C)	mA / °C
ED	Pulse forward current	I _{FP}	1 (100µs pulse, 100pps)	Α
	Reverse voltage	V _R	5	V
	Junction temperature	Tj	125	°C
	Collector-emitter voltage	V _{CEO}	300	V
	Emitter-collector voltage	V _{ECO}	0.3	V
ţo	Collector current	I _C	150	mA
Detector	Collector power dissipation	P _C	150	mW
	Collector power dissipation derating (Ta ≥ 25°C)	ΔP _C / °C	-1.5	mW / °C
	Junction temperature	Tj	125	°C
Stor	rage temperature range	T _{stg}	-55~125	°C
Operating temperature range		T _{opr}	−55 ~ 100	°C
Lead soldering temperature		T _{sol}	260 (10s)	°C
Total package power dissipation		P _T	200	mW
Total package power dissipation derating (Ta ≥ 25°C)		ΔP _T / °C	-2.0	mW / °C
Isola	ation voltage (Note 1)	BV _S	2500 (AC, 1min., R.H.≤ 60%)	Vrms

(Note 1) Device considered a two terminal device: Pins 1, 3 shorted together and pins4, 6 shorted together.

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Individual Electrical Characteristics (Ta = 25°C)

	Characteristic	Symbol	Test Condition	Min.	Тур.	Max.	Unit
	Forward voltage	V _F	I _F = 10 mA	1.0	1.15	1.3	V
E	Reverse current	I _R	VR = 5V	_	_	10	μΑ
	Capacitance	C _T	V = 0, f = 1 MHz	_	30	_	pF
	Collector–emitter breakdown voltage	V _(BR) CEO	I _C = 0.1 mA	300	_	_	V
ctor	Emitter-collector breakdown voltage	V _(BR) ECO	I _E = 0.1 mA	0.3	_	_	V
Detector	Collector dark current I _{CEO}	lana	V _{CE} = 200 V	_	10	200	nA
		V _{CE} = 200 V, Ta = 85°C	_	_	20	μA	
	Capacitance collector to emitter	C _{CE}	V = 0, f = 1 MHz		12	_	pF

Coupled Electrical Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Condition	MIn.	Тур.	Max.	Unit
Current transfer ratio	I _C / I _F	I _F = 1mA, V _{CE} = 1 V	1000	4000	_	%
Saturated CTR	I _C / I _{F (sat)}	I _F = 10 mA, V _{CE} = 1 V	500	_	_	%
Collector–emitter saturation voltage	V0= ())	I _C = 10 mA, I _F = 1 mA	_	_	1.0	V
	V _{CE (sat)}	I _C = 100 mA, I _F = 10 mA	0.3	_	1.2	

Isolation Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Condition	Min.	Тур.	Max.	Unit
Capacitance (input to output)	CS	V _S = 0, f = 1 MHz	1	0.8	_	pF
Isolation resistance	R _S	V _S = 500 V, R.H.≤ 60%	5×10 ¹⁰	10 ¹⁴	_	Ω
		AC, 1 minute	2500	_	_	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \
Isolation voltage	BV_S	AC, 1 second, in oil	_	5000	_	V _{rms}
		DC, 1 minute, in oil	_	5000	_	V _{dc}

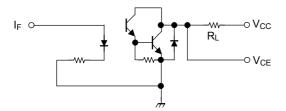
Switching Characteristics (Ta = 25°C)

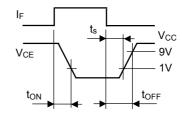
Characteristic	Symbol	Test Condition	Min.	Тур.	Max.	Unit
Rise time	t _r		_	40	_	μs
Fall time	t _f	V _{CC} = 10 V, I _C = 10 mA	_	15	_	
Turn-on time	t _{on}	R _L = 100 Ω	_	50	_	
Turn-off time	t _{off}		_	15	_	
Turn-on time	t _{ON}		_	5	_	
Storage time	ts	$R_L = 180 \Omega$ (Fig.1) $V_{CC} = 10 V, I_F = 16 \text{ mA}$	_	40	_	μs
Turn-off time	t _{OFF}		_	80	_	

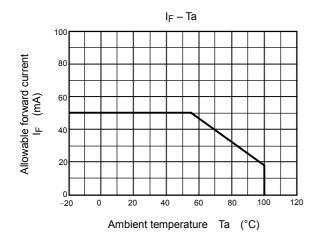
Recommended Operating Conditions

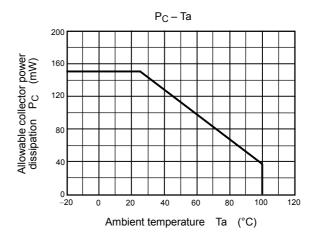
Characteristic	Symbol	Min.	Тур.	Max.	Unit
Supply voltage	V _{CC}	_	_	200	V
Forward current	l _F	_	16	25	mA
Collector current	IC	_	_	120	mA
Operating temperature	T _{opr}	-25	_	85	°C

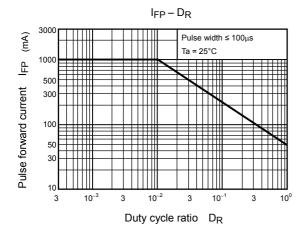
Fig. 1 Switching time test circuit

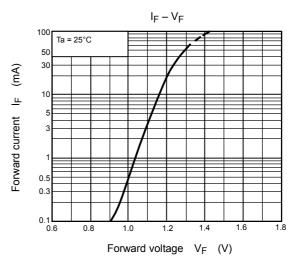


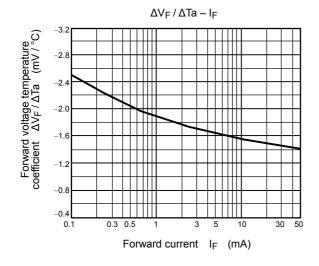


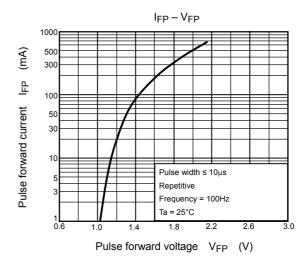




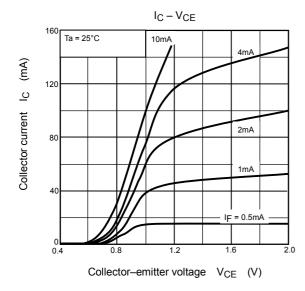


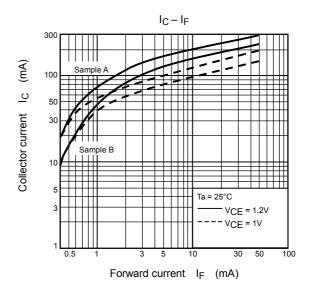


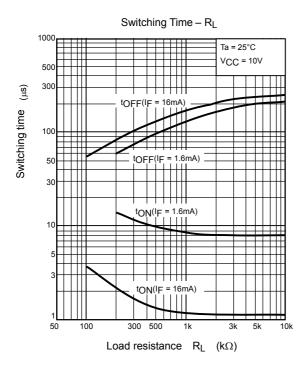


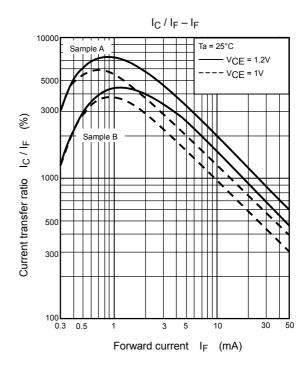


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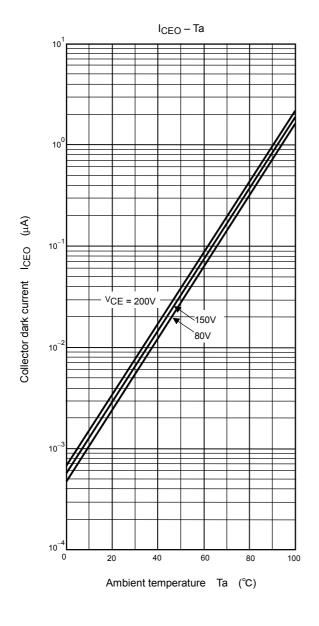


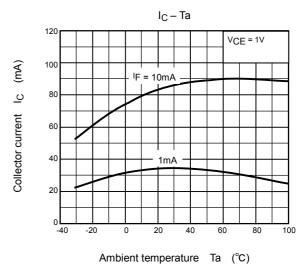


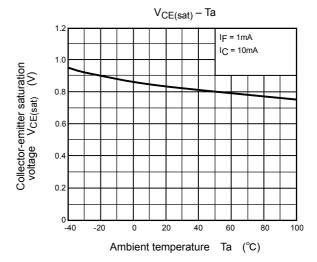




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